

规格书编号

SPEC NO:

产品规格书 SPECIFICATION

| CUSTOMER 客 户: | | | | | | |
|-------------------------|-------------|----------------------|--|--|--|--|
| PRODUCT 产品: | SAW FILTER | | | | | |
| MODEL NO 型 号: | HDF454BS4 | | | | | |
| PREPARED 编 制: | CHECKED 审 核 | ﴿: | | | | |
| APPROVED 批 准: | DATE 日 期 | 月 : 2006−5−11 | | | | |
| 客户确认 CUSTOMER RECEIVED: | | | | | | |
| | | | | | | |
| 审核 CHECKED | 批准 APPROVED | 日期 DATE | | | | |
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无锡市好达电子有限公司 Shoulder Electronics Limited



SAW FILTER HDF454BS4

更改历史记录 History Record

| 更改日期 Date | 规格书编号 Spec. No. | 产品型号 Part No. | 客户产品型号 Customer No. | 更改内容描述 Modify Content | 备注 Remark |
|--------------|--------------------|------------------|------------------------|--------------------------|--------------|
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1. SCOPE

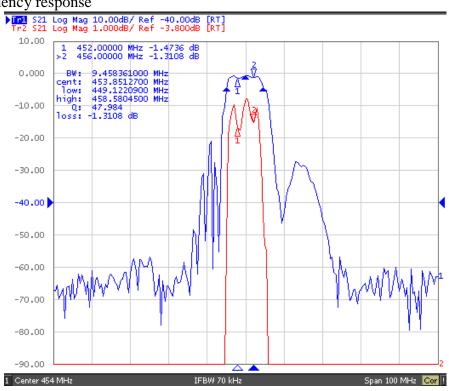
This specification shall cover the characteristics of SAW filter With F454 used for the page system.

2. ELECTRICAL SPECIFICATION

| DC Voltage VDC | 10V | |
|-----------------------|----------------|--|
| AC Voltage Vpp | 10V50Hz/60Hz | |
| Operation temperature | -40°C to +85°C | |
| Storage temperature | -45°C to +85°C | |
| RF Power Dissipation | 0dBm | |

Electronic Characteristics

2-1. Typical frequency response

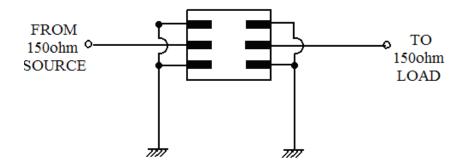


2-2. Electrical characteristics

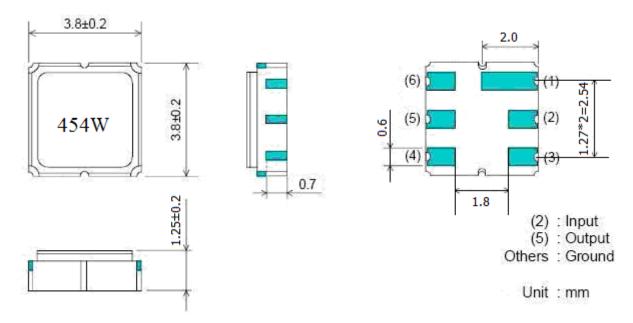
| Part number | F454B | Unit |
|---|-----------------------------|------|
| Center frequency (Fo) | 454 | MHz |
| Insertion Loss 1.fo-45.8~fo-39.8 MHz 2.fo±2.0 MHz 3.fo+39.8~ fo+45.8MHz | 45min. 4.5max. 45min. | dB |
| Ripple (with Fo ± 2.0 MHz) | 2.0max | dB |
| Input/Output Impedance(Nominal) | 150//0 | Ω/pF |



3. TEST CIRCUIT



4. DIMENSION



5. ENVIRONMENTAL CHARACTERISTICS

5-1 High temperature exposure

Subject the device to $+85^{\circ}$ C for 16 hours. Then release the filter into the room conditions for 24 hours prior to the measurement. It shall fulfill the specifications in 2-2.

5-2 Low temperature exposure

Subject the device to -40° C for 16 hours. Then release the device into the room conditions for 24 hours prior to the measurement. It shall fulfill the specifications in 2-2.

5-3 Temperature cycling

Subject the device to a low temperature of -40° C for 30 minutes. Following by a high temperature of $+85^{\circ}$ C for 30 Minutes. Then release the device into the room conditions for 24 hours prior to the measurement. It shall meet the specifications in 2-2.

5-4 Resistance to solder heat

Dip the device terminals no closer than 1.5mm into the solder bath at 260° C $\pm 10^{\circ}$ C for 10 ± 1 sec. Then release the device into the room conditions for 4 hours. The device shall meet the specifications in 2-2.



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5-5 Solderability

Subject the device terminals into the solder bath at 245° C $\pm 5^{\circ}$ C for 5s, More than 95% area of the terminals must be covered with new solder. It shall meet the specifications in 2-2.

5-6 Mechanical shock

Drop the device randomly onto the concrete floor from the height of 1m 3 times. the device shall fulfill the specifications in 2-2.

5-7 Vibration

Subject the device to the vibration for 1 hour each in x,y and z axes with the amplitude of 1.5 mm at 10 to 55 Hz. The device shall fulfill the specifications in 2-2.

6. REMARK

6.1 Static voltage

Static voltage between signal load & ground may cause deterioration &destruction of the component. Please avoid static voltage.

6.2 Ultrasonic cleaning

Ultrasonic vibration may cause deterioration & destruction of the component. Please avoid ultrasonic cleaning

6.3 Soldering

Only leads of component may be soldered. Please avoid soldering another part of component.